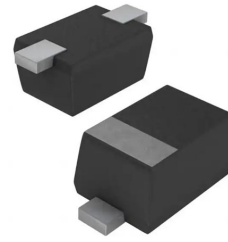


Features

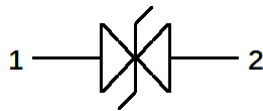
- * Ultra low leakage: nA level
- * Low clamping voltage
- * RoHS Compliant
- * REACH & SVHC Compliant
- * Halogen Compliant
- * SOD-523 Package



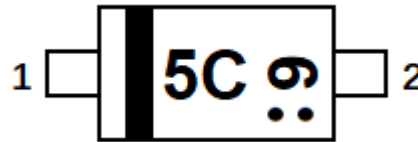
Ordering Information

Part Number	Packaging	Reel Size
DESD5V0S1BB-7-CN	5000/Tape & Reel	7 inch

Circuit Diagram



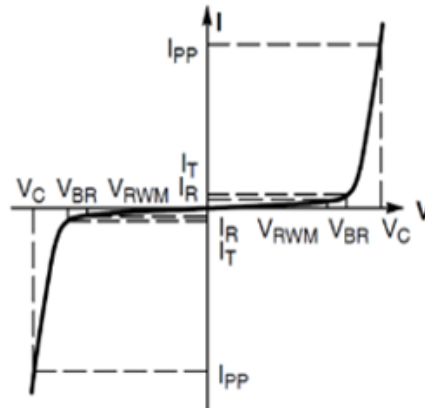
Marking Diagram



Top view

Portion Electronics Parameter

Symbol	Parameter
V_{RWM}	Peak Reverse Working Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_R
I_T	Test Current
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}



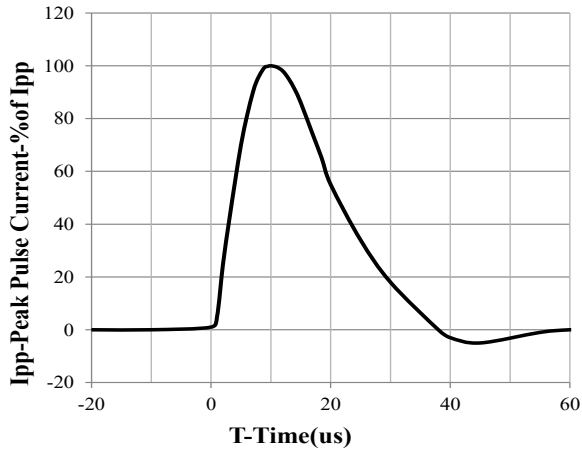
Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 μs pulse)	P_{pk}	120	W
Peak Pulse Current (8/20 μs pulse)	I_{PP}	10	A
ESD per IEC 61000-4-2 (Air)	V_{ESD}	± 30	kV
ESD per IEC 61000-4-2 (Contact)		± 30	
Operating Temperature Range	T_J	-40 to +125	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^{\circ}\text{C}$

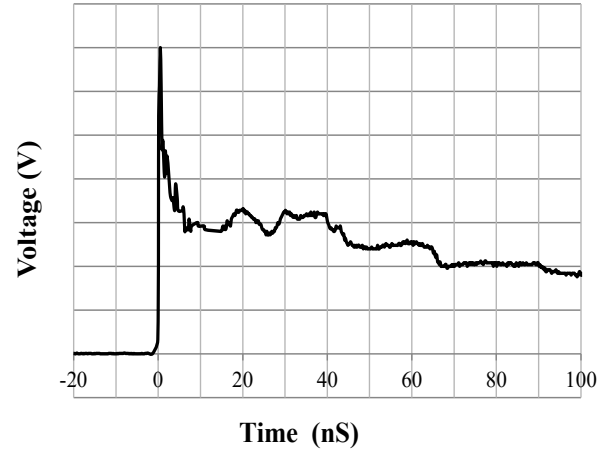
Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				5	V
Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	6	7.1	8.5	V
Reverse Leakage Current	I_R	$V_{RWM} = 5\text{V}$		<10	100	nA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}$ (8 / 20 μs pulse)		7.1	9	V
Clamping Voltage	V_C	$I_{PP} = 10\text{A}$ (8 / 20 μs pulse)		8.3	12	V
Junction Capacitance	C_J	$V_R = 0\text{V}$, $f = 1\text{MHz}$,		17	25	pF

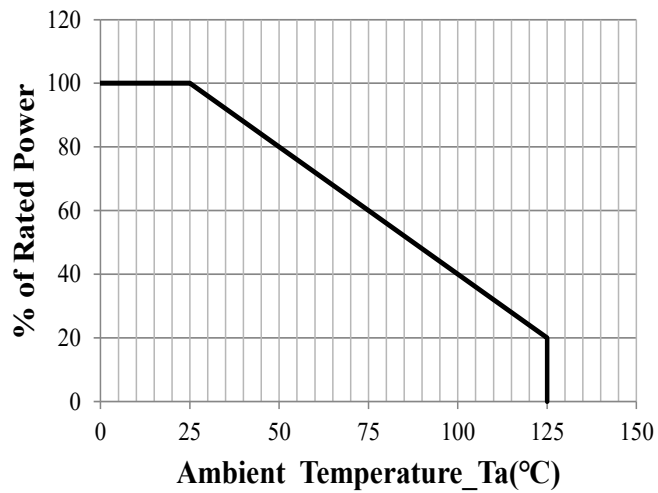
Typical Performance Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise Specified)



8 / 20us Pulse Waveform

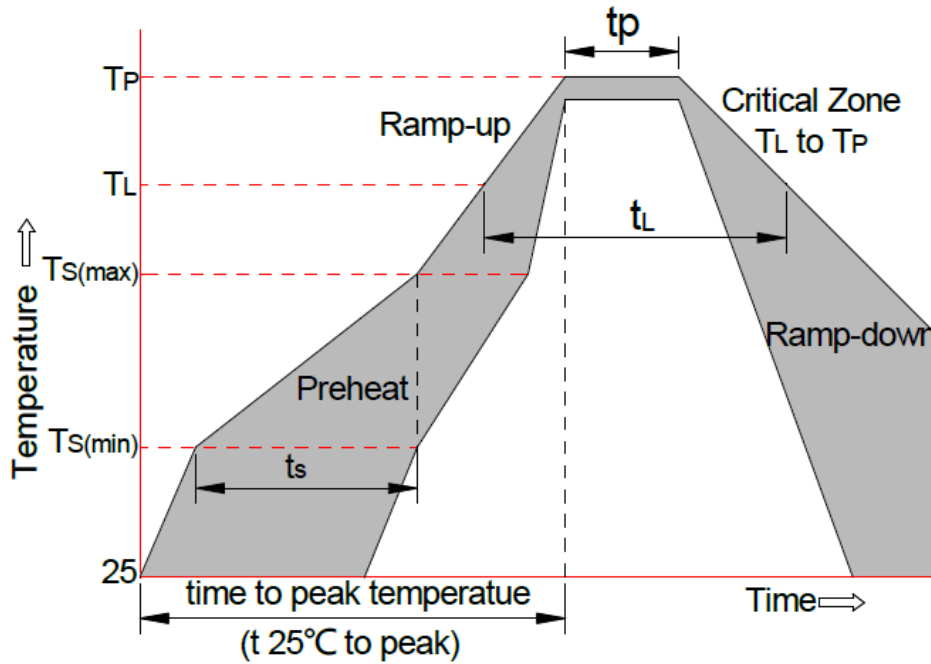


IEC61000-4-2 Pulse Waveform



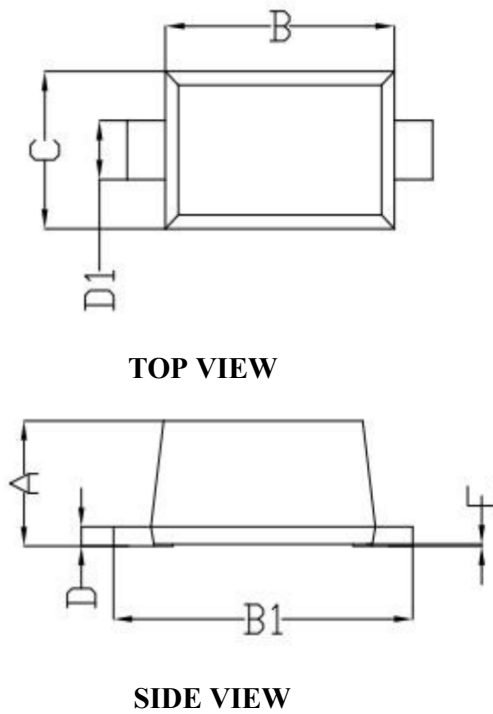
Power Derating Curve

Soldering Parameters



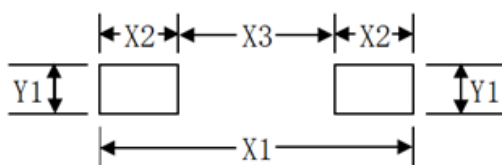
Reflow Condition		Pb-Free Assembly
Pre-heat	-Temperature Min ($T_{S(min)}$)	+150°C
	-Temperature Max ($T_{S(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs
Average ramp up rate(Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{S(max)}$ to T_L -Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature (T_L) (Liquid us)	+217°C
	-Temperature (t_L)	60-150 secs
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6 °C/secs. Max
xTime 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

SOD-523 Package Outline Drawing



SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	Min	Typ	Max	Min	Typ	Max
A	0.60	0.65	0.70	0.0236	0.0256	0.0276
B	1.15	1.20	1.25	0.0453	0.0472	0.0492
B1	1.55	1.60	1.65	0.0610	0.0630	0.0650
C	0.75	0.80	0.85	0.0295	0.0315	0.0335
D	0.10	0.11	0.12	0.0039	0.0043	0.0047
D1	0.28	0.30	0.32	0.0110	0.0118	0.0126
E	0.00	-	0.02	0.0000	-	0.0008

Suggested Land Pattern



SYM	DIMENSIONS	
	MILLIMETER	INCHES
X1	2.00	0.079
X2	0.60	0.024
X3	0.80	0.031
Y1	0.50	0.020

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